

Product data sheet

1. General description

Dual ultrafast power diode in a SOT429 (3-lead TO-247) plastic package.

2. Features and benefits

- Very low on-state loss
- Fast switching
- Soft recovery characteristic minimizes power consuming oscillations
- High reverse surge capability
- High thermal cycling performance
- Low thermal resistance

3. Quick reference data

Table 1. Qui	ck reference data						
Symbol	Parameter	Conditions	IV	lin	Тур	Max	Unit
V _R	reverse voltage	DC	-		-	200	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 113 °C; square-wave pulse; per diode; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>	-		-	15	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode; Fig. 4	-		-	170	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	-		-	185	A
Static chara	acteristics						
V _F	forward voltage	I _F = 15 A; T _j = 25 °C; <u>Fig. 6</u>	-		0.95	1.05	V
		I _F = 30 A; T _j = 25 °C; <u>Fig. 6</u>	-		1	1.2	V
		I _F = 15 A; T _j = 150 °C; <u>Fig. 6</u>	-		0.78	0.9	V
Dynamic ch	naracteristics	·					
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/µs; T _j = 25 °C; <u>Fig. 7</u>	-		20	28	ns

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4. Pinning information

Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	A1	anode 1						
2	К	cathode						
3	A2	anode 2		K sym125				
mb	К	mounting base; cathode	↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓					

5. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
BYV72EW-200	TO-247	plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3 lead TO-247	SOT429			



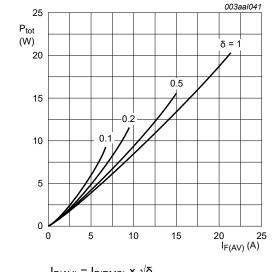
6. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	200	V
V _{RWM}	crest working reverse voltage		-	200	V
V _R	reverse voltage	DC; T _{mb} ≤ 144 °C	-	200	V
I _{F(AV)}	average forward current	δ = 0.5; T _{mb} ≤ 113 °C; square-wave pulse; per diode; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>	-	15	A
I _{O(AV)}	average output current	δ = 0.5 ; T _{mb} ≤ 104 °C; square-wave pulse; both diodes conducting	-	30	A
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse; per diode; <u>Fig. 4</u>	-	170	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	-	185	A
I _{RRM}	repetitive peak reverse current	δ = 0.001; t _p = 2 µs; per diode	-	0.2	A
I _{RSM}	non-repetitive peak reverse current	t _p = 100 μs; per diode	-	0.2	A
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	150	°C
Electrostatio	c discharge	· · · ·			
V _{ESD}	electrostatic discharge voltage	HBM; C = 250 pF; R = 1.5 kΩ	-	8	kV

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 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta} \\ V_o = 0.744 \; V; \; R_s = 0.010 \; \Omega$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; per diode; maximum values

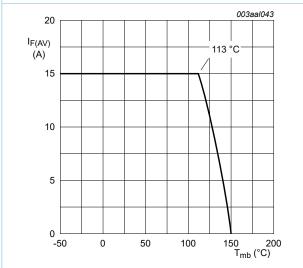
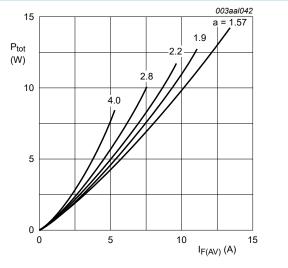
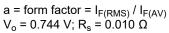


Fig. 3. Average forward current as a function of mounting base temperature; per diode; maximum values







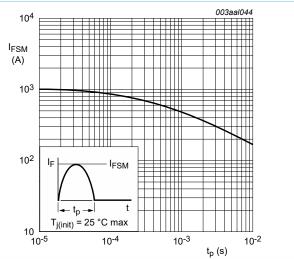


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; per diode; maximum values

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7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	with heatsink compound; per diode; Fig. 5	-	-	2.4	K/W
		with heatsink compound; both diodes conducting	-	-	1.4	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W

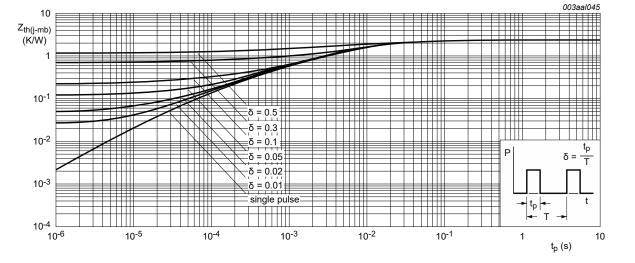


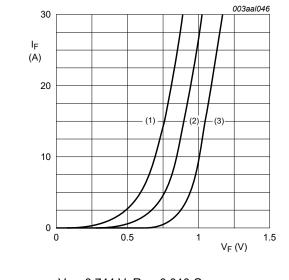
Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse width; per diode; maximum values

8. Characteristics

Table 6. Characteristics

characteristics are per diode unless otherwise stated

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _F	forward voltage	I _F = 15 A; T _j = 25 °C; <u>Fig. 6</u>	-	0.95	1.05	V
		I _F = 30 A; T _j = 25 °C; <u>Fig. 6</u>	-	1	1.2	V
		I _F = 15 A; T _j = 150 °C; <u>Fig. 6</u>	-	0.78	0.9	V
I _R	reverse current	V _R = 200 V; T _j = 25 °C	-	10	100	μA
		V _R = 200 V; T _j = 100 °C	-	0.5	1	mA
Dynamic ch	haracteristics	·				
t _{rr}	reverse recovery time	I_F = 1 A; V _R = 30 V; dI _F /dt = 100 A/µs; T _j = 25 °C; <u>Fig. 7</u>	-	20	28	ns
Q _r	recovered charge	I _F = 2 A; V _R = 30 V; dI _F /dt = 20 A/μs; T _j = 25 °C; <u>Fig. 7</u>	-	6	15	nC
V _{FR}	forward recovery voltage	I _F = 1 A; dI _F /dt = 10 A/μs; T _j = 25 °C; Fig. 8	-	1	-	V



V_o = 0.744 V; R_s = 0.010 Ω (1) T_j = 150 °C; typical values (2) T_j = 150 °C; maximum values (3) T_j = 25 °C; maximum values



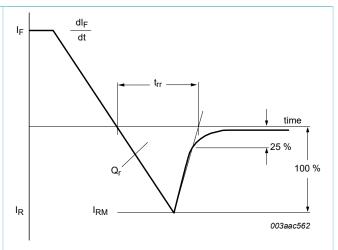
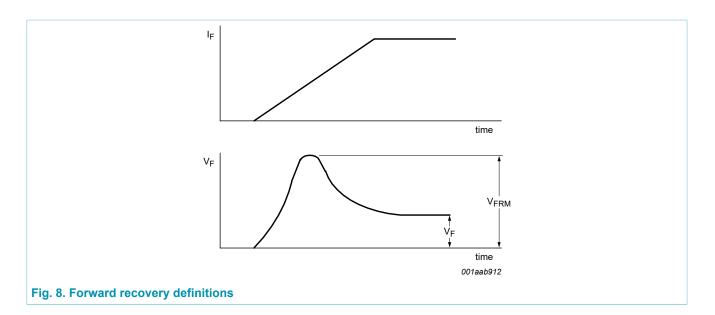


Fig. 7. Reverse recovery definitions; ramp recovery

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BYV72EW-200

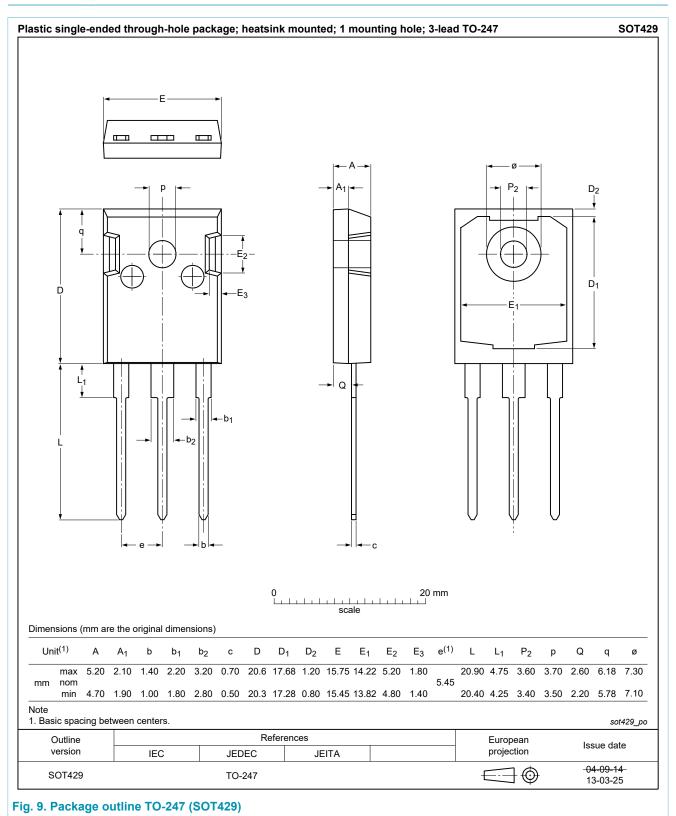
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9. Package outline



BYV72EW-200

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10. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

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